# RZ/V2M Evaluation Board Kit Start-Up Guide

User's Manual



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## How to Use This Manual

## 1. Objective and Target Users

This manual sets out initial procedures for operating the RZ/V2M evaluation board kit. Note that this manual is not intended for use in software development.

This document shows the installation and startup procedure of the first boot loader, second boot loader, and U-Boot on the RZ/V2M evaluation board kit. For details and notes on the RZ/V2M evaluation board kit, refer to *the RZ/V2M Evaluation Board Kit Hardware Manual*.

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## RENESAS

## RZ/V2M Evaluation Board Kit Start-Up Guide

#### Introduction

This document shows the startup procedure of the first boot loader, second boot loader, and U-Boot on the RZ/V2M evaluation board kit (V2MEVK).

For details on the procedure, refer to *the RZ/V2M Linux Package Manual*. Descriptions in this document are based on *the RZ/V2M Linux Package Rev1.2*. When referring to the different package version, follow the descriptions in that document.

#### **Related Documents**

The following documents have been prepared for this V2MEVK. Make sure to refer to the latest versions of these documents.

Document Type	Document Title	Document No.	Description
Startup guide	V2MEVK Startup Guide	This document	Startup procedure of the V2MEVK
User's manual: Hardware	RZ/V2M User's Manual: Hardware	R01UH0940EJ0120	RZ/V2M hardware specifications (pin assignments, memory maps, peripheral specifications, electrical characteristics, and timing charts) and descriptions of operation
Linux startup guide	RZ/V2M Linux Package Startup Guide	R01US0527EJ0120	Startup procedure of the RZ/V2M Linux package



## 1. **Operating Environment**

**Table 2.1-1** lists the recommended environment for V2MEVK operation and Figure 2.1-1 shows the connection method.

Equipment	Details		
RZ/V2M evaluation board kit	Evaluation board kit for RZ/V2M		
Windows PC	For controlling the target board with terminal software		
OS	Windows 10 recommended		
Terminal software	Control serial console of the target board. Tera Term is recommended and available at " <u>Tera Term Open Source Project</u> (osdn.jp)".		
VCP driver	Virtual COM port driver to enable communications between the Windows PC and the target board via USB. This is virtually used as a serial port and available at " <u>CP210x</u> <u>USB to UART Bridge VCP Drivers - Silicon Labs (silabs.com</u> )". Install "CP210x VCP Windows" at the above web site.		
Serial to micro–USB cable (USB cable: Standard-A-Micro-B)	Serial communications (UART) between the RZ/V2M evaluation board kit and Windows PC		
Micro–SD card	Used to write the flash writer software to the V2MEVK. Use it as SDHC, formatted as FAT32, with one partition.		
AC adapter	12 V, 5 A (Plug: Inner diameter 2.1 mm, outer diameter 5.5 mm)		

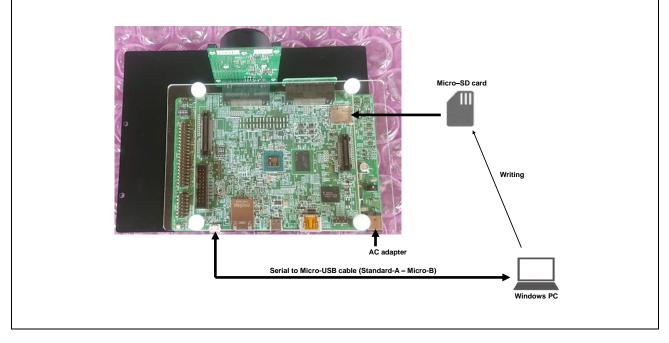


Figure 2.1-1 Connection Method



## 2. Startup Procedure

This section describes the procedure for writing the first boot loader, second boot loader, and U-Boot required to boot the Linux kernel. This procedure is accomplished by executing the following two functions in order.

- 1. SD card forced write function
- 2. Flash writer write function

For details, see section 7, Flash Writer, in the RZ/V2M Linux Package Startup Guide.

Download the latest version of the following software package from the Renesas Web site.

Software Package	Description
RZ/V2M Linux Package	Linux package for the RZ/V2M

RZ/V2M — AI-only Accelerator (DRP-AI), 4K-compatible Image Signal Processor (ISP), Vision-AI ASSP for Realtime Human and Object Recognition (2022.4)

https://www.renesas.com/jp/en/products/microcontrollers-microprocessors/rz-cortex-a-mpus/rzv2m-dualcortex-a53-lpddr4x32bit-ai-accelerator-isp-4k-video-codec-4k-camera-input-fhd-display-output

## 2.1 Flash Writer Writing Procedure (using SD Card Forced Write Function)

#### 2.1.1 Preparing the SD Card

Store the files included in the RZ/V2M Linux package on an SD card.

1. SD card format specifications

— FAT32

- 1 partition
- SDHC
- Store the flash writer software on SD card The files to be stored are included in the following directory of the Linux package.

r01an5971ej0<xxx>-rzv2m-linux (<xxx>: Package version)

└─ option

└─ flash\_writer

└─ B2\_intSW.bin



### 2.1.2 Writing Flash Writer Software (SD Card Forced Write Execution)

Write the prepared file (Flash writer, file name: B2\_intSW.bin) to  $eMMC^{TM}$  on the board by using the forced write function of RZ/V2M.

- 1. With the V2MEVK board power turned off, insert the prepared SD card into the V2MEVK's CN6 connector and set SW2 (see **Figure 2.1-1** for the SW2 setting method)
- 2. Turn on SW501 of V2MEVK
- 3. The RZ/V2M automatically acquires data from the SD card and writes the data to eMMC. LED2 lights up when writing is successfully completed.

#### SUPPLEMENTARY EXPLANATION

If LED2 is blinking, the write operation has failed and an error may have occurred on the SD card. Check whether the SD card is inserted and formatted correctly.

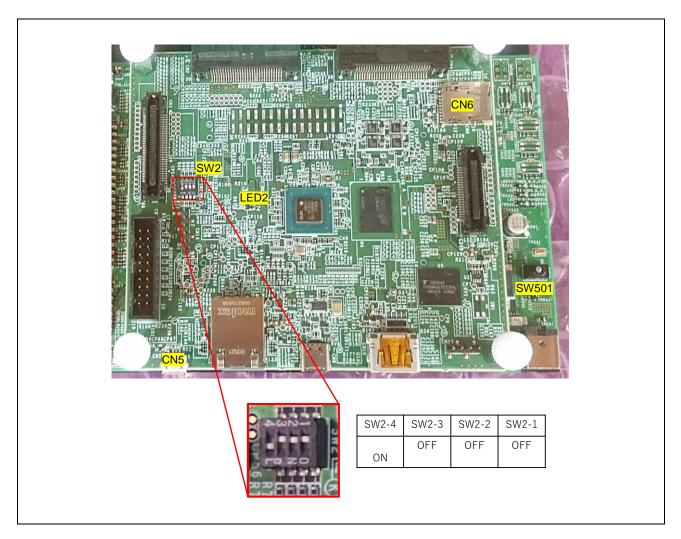


Figure 2.1-1 SW2 Settings



## 2.2 Writing Procedure for First Boot Loader, Second Boot Loader, and U-Boot (Using Flash Writer Writing Function)

### 2.2.1 Starting Flash Writer

Start the flash writer written in section 2.1 Flash Writer Writing Procedure (using SD Card Forced Write Function).

- 1. Turn off SW501 of V2MEVK
- 2. Turn off all SW2 switches (SW2-1, SW2-2, SW2-3, and SW2-4) of V2MEVK
- 3. Connect CN5 of V2MEVK and the Windows PC with a USB cable (standard-A-micro-B) and start Tera Term. See **Figure 2.2-1** for Tera Term settings.
- Turn on SW501 of V2MEVK Check that the display is as shown in Figure 2.2-2.
  - Note: Figure 2.2-1 shows the configuration for RZ/V2M Linux Package Ver1.2. If you will be using a different version, refer to the RZ/V2M Linux Package Startup Guide for that version.

Tera Term: Serial port se	etup and connection		×	
Port: Speed:	COM5 ~	New setting		
Data: Parity:	8 bit ~	Cancel		
Stop bits: Flow control:	1 bit ~	Help		
0 Tera Term: Terminal setu	msec/char 0	msec/line	×	
Terminal size 80 X 2 Term size = win size = window results = window result	4 New-line Receive: iize Transmit:	AUTO ~ CR ~ C	OK ancel telp	
Terminal ID: VT10 Answerback:		al echo o switch (VT<->TEK)		
Kanji (receive) UTF-8 ~ Half-width kana	Kanji (transmit) UTF-8 ~ Half-width kana	Kanji-in: ^[		

Figure 2.2-1 Settings of Tera Term



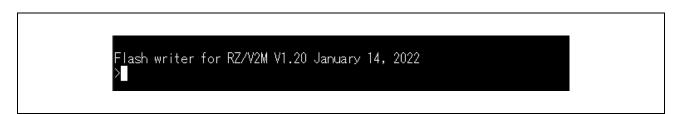


Figure 2.2-2 Starting the Flash Writer



#### 2.2.2 Erasing the Area to be Written in eMMC

Erase the area in the eMMC for storing (writing) the first and second boot loaders and U-Boot.

1. Refer to **Table 2.2-1** and enter the contents of the input column with Tera Term.

Table 2.2-1 Procedure of eMMC Initialization

Step	Tera Term Display	Input	Supplemental Information	
1	>	EM_E	The first and second boot loaders and U-Boot are stored in boot	
2	Select area(0-2)>	1	partition 1. For the sector number of boot partition 1 that firs and second boot loaders and U-Boot are stored, refer to Fi	
3	EM_E Complete!	_	<b>2.2-5</b> .	

Figure 2.2-3 shows an example of the screen display when the above procedure is successfully executed.

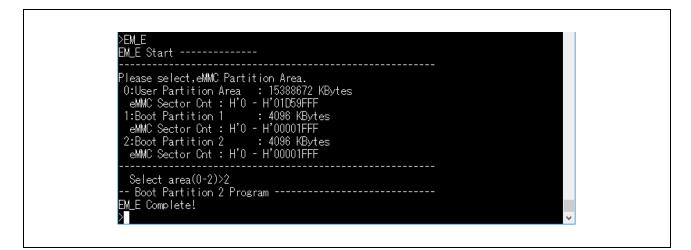


Figure 2.2-3 EM\_E Command



#### 2.2.3 Writing the First Boot Loader, Second Boot Loader, and U-Boot

Write first boot loader, second boot loader, and U-Boot, respectively, to eMMC.

1. Storage location of sample first boot loader, second boot loader, and U-Boot

The files to be written are included in the following directory of the Linux package.

r01an5971ej0<xxx>-rzv2m-linux (<xxx>: Package version)

└\_ bin

- loader\_1st\_128kb.bin
- loader\_2nd.bin
- loader\_2nd\_param.bin
- u-boot.bin
- └─ u-boot\_param.bin
- 2. Execute writing of first boot loader Use the flash writer function for writing.
- 3. Refer to **Table 2.2-2** and enter the contents of the input column with Tera Term. The following is an example of the first boot loader (file name to be written: loader\_1st\_128kb.bin).

Table 2.2-2 Procedure of Writing the Binary File

Step	Tera Term Display	Input	Supplemental Information
1	>	EM_WB	_
2	Select area(0-2)>	1	See Figure 2.2-5 for details on specifying parameters.
3	Please Input Start Address in sector:	000	(For details, see Table 7-3, Boot loader data stored in the eMMC
4	Please Input File size(byte):	20000	— in the RZ/V2M Linux Package Startup Guide.)
5	Please send binary file!	_	This control should be executed by the file transfer function, not by Tera Term command input.
			1. Click "File" and "Send file"
			2 Select "loader_1st_128kb.bin"
			3. Check "Binary" in "Option". (see Figure 2.2-4)
			4. Click "Open".
6	EM_WB Complete!	_	_

🧕 Tera Term: Send file		×	
Look in: bin	✓ Ø Ø Ø №		
Name	Date modified	Туре	
core-image-bsp-rzv2m.tar.bz2	1/26/2022 3:05 PM	BZ2 File	
Image	1/26/2022 3:05 PM	File	
loader_1st_128kb.bin	1/26/2022 3:05 PM	BIN File	
loader_2nd.bin	1/26/2022 3:05 PM	BIN File	
loader_2nd_param.bin	1/26/2022 3:05 PM	BIN File	
r9a09g011gbg-evaluation-board.dtb	1/26/2022 3:05 PM	DTB File	
u-boot.bin	1/26/2022 3:05 PM	BIN File	
u-boot_param.bin	1/26/2022 3:05 PM	BIN File	
<		>	
File name: loader_1st_128kb.bin		Open	
Files of type: All(*.*)	~	Cancel	
		Help	
		2.4	
Option			
Binacy	_		
Check this box.			
encer and box			

Figure 2.2-4 File Transmission



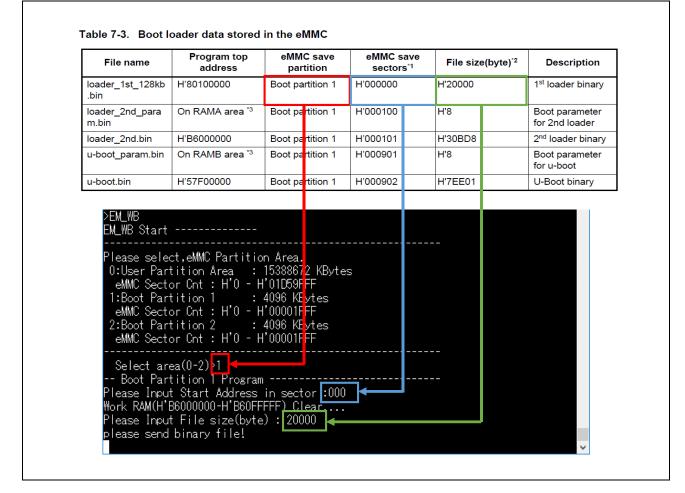


Figure 2.2-5 EM\_WB Command (Determining the Specified Parameters)

- Execution of writing second boot loader and U-Boot
   Writing the second boot loader and U-Boot also requires use of the functions of the flash writer. Change the following from the procedure for the first boot loader (file name to be written: loader\_1st\_128kb.bin) and write it.
  - 4-1) Change the parameters specified in STEP 2 to 4.
  - 4-2) Change the name of the file to be sent
    - Second boot loader: "loader\_2nd.bin", "loader\_2nd\_param.bin" U-Boot: "u-boot.bin", "u-boot\_param.bin"



## 2.3 Startup with Written Information

Boot V2MEVK with the respective data for the first boot loader, second boot loader, and U-Boot that have been written to eMMC.

- 1. Turn off SW501 of V2MEVK
- 2. Turn on SW501 of V2MEVK
- 3. Restart V2MEVK and if the display is as shows in **Figure 2.3-1**, startup is complete.

[BL1] Boot Loader Version 1.20 [BL1] eMMC initialized [BL1] Loaded the boot parameter for 2nd boot [BL1] Loaded the 2nd boot loader [BL1] Kick the 2nd boot loader [BL2] 2nd boot loader entered [BL2] DDR initialization completed_M [BL2] Loaded the boot parameter for U-Boot [BL2] Loaded the U-Boot [BL2] the U-Boot start	
U-Boot 2018.09 (Jan 12 2022 - 10:07:36 +0000)	
Model: RZ/V2M DRAM: 4 GiB MMC: sd@85000000: 0, sd@85020000: 1 Loading Environment from MMC *** Warning - bad CRC, using default environm	hent
In: serial Out: serial Err: serial Net: eth0:ethernet@a3300000 Hit any key to stop autoboot: 0 ** Unable to read file Image ** ** Unable to read file r9a09g011gbg-evaluation-board.dtb ** Bad Linux ARM64 Image magic! =>	

Figure 2.3-1 U-Boot Startup Display



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